

Title (en)  
Method for improving or giving physical and chemical properties to items to be placed in contact with the skin, and item obtained with the method

Title (de)  
Verfahren zur Verbesserung oder zum Verleihen von physikalischen oder chemischen Eigenschaften der Artikel, die die Haut berühren, und sich daraus ergebenden Artikel

Title (fr)  
Procédé pour améliorer ou donner des propriétés physiques et chimiques à des articles placés en contact avec la peau, et articles ainsi obtenus

Publication  
**EP 1559336 A1 20050803 (EN)**

Application  
**EP 04011658 A 20040517**

Priority  
IT MI20040136 A 20040129

Abstract (en)  
A method for improving or giving physical and chemical properties to items to be placed in contact with the skin and an item obtained with the method, the method comprising the steps of applying a supporting layer (2) to an item (1) for which particular physical and chemical properties are to be improved or to which one wishes to give particularly physical and chemical properties; the supporting layer (2) incorporates at least one granular substance (3,3a) that has, or can develop, by interaction with the item or with the skin of the user, physical and chemical properties. <IMAGE>

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**A41D 31/00**

IPC 8 full level  
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CPC (source: EP)  
**A41B 11/00** (2013.01); **A41B 2400/32** (2013.01); **A41B 2400/36** (2013.01)

Citation (search report)  

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